

Chipsmall Limited consists of a professional team with an average of over 10 year of expertise in the distribution of electronic components. Based in Hongkong, we have already established firm and mutual-benefit business relationships with customers from, Europe, America and south Asia, supplying obsolete and hard-to-find components to meet their specific needs.

With the principle of "Quality Parts, Customers Priority, Honest Operation, and Considerate Service", our business mainly focus on the distribution of electronic components. Line cards we deal with include Microchip, ALPS, ROHM, Xilinx, Pulse, ON, Everlight and Freescale. Main products comprise IC, Modules, Potentiometer, IC Socket, Relay, Connector. Our parts cover such applications as commercial, industrial, and automotives areas.

We are looking forward to setting up business relationship with you and hope to provide you with the best service and solution. Let us make a better world for our industry!



# Contact us

Tel: +86-755-8981 8866 Fax: +86-755-8427 6832

Email & Skype: info@chipsmall.com Web: www.chipsmall.com

Address: A1208, Overseas Decoration Building, #122 Zhenhua RD., Futian, Shenzhen, China







ISSUE: October 12,2016

TO;

# SPECIFICATIONS

	Product 1	Name PHOT	OCOUPLER	
	Model No	p. PC81	7	·
	[Business	dealing name:	PC817X*NIP1B	1
Accepted	These specifications cont This specification sheets After confirmation of th Specifications with appr If you have any objection	s and attached she e contents, please coving signature o	ets shall be both side be sure to send back a each.	de copy. kcopy of the
By: Name: Title: Date:  Name: Title: Date:		By:	_	rision. V usiness Unit onents and Devices BU
		By :	wed by:  So. T.Okuda Senior Manager  L. Oct., 2016	Prepared by:  By:  Name: H.Shoji  Title: Supervisor  Date: 12. Oct, 2016

# SHARP

# REFERENCE

- 1. These specification sheets include materials protected under copyright of Sharp Corporation ("Sharp"). Please handle with great cares and do not reproduce or cause anyone to reproduce them without Sharp's consent.
- 2. When using this Sharp product, please observe the absolute maximum ratings, other conditions and instructions for use described in the specification sheets, as well as the precautions mentioned below.
  Sharp assumes no responsibility for any damages resulting from use of the product which does not comply with absolute.

Sharp assumes no responsibility for any damages resulting from use of the product which does not comply with absolute maximum ratings, other conditions and instructions for use included in the specification sheets, and the precautions mentioned below.

#### (Precautions)

- (1) In making catalogue or instruction manual based on the specification sheets, please verify the validity of the catalogue or instruction manuals after assembling Sharp products in customer's products at the responsibility of customer.
- (2) This Sharp product is designed for use in the following application areas;
  - Computers OA equipment Telecommunication equipment (Terminal) Measuring equipment
  - Tooling machines Audio visual equipment Home appliances

If the use of the Sharp product in the above application areas is for equipment listed in paragraphs (3) or (4), please be sure to observe the precautions given in those respective paragraphs.

- (3) Appropriate measures, such as fail-safe design and redundant design considering the safety design of the overall system and equipment, should be taken to ensure reliability and safety when Sharp product is used for equipment in responsibility of customer which demands high reliability and safety in function and precision, such as;
  - Transportation control and safety equipment (aircraft, train, automobile etc.)
  - Traffic signals Gas leakage sensor breakers Rescue and security equipment
  - Other safety equipment
- (4)Sharp product is designed for consumer goods and controlled as consumer goods in production and quality. Please do not use this product for equipment which require extremely high reliability and safety in function and precision, such as;
  - Space equipment Telecommunication equipment (for trunk lines)
  - Nuclear power control equipment Medical equipment
- (5) Please contact and consult with a Sharp sales representative if there are any question regarding interpretation of the above four paragraphs.
- 3. Disclaimer

The warranty period for Sharp product is one (1) year after shipment.

During the period, if there are any products problem, Sharp will repair (if applicable), replace or refund.

Except the above, both parties will discuss to cope with the problems.

The failed Sharp product after the above one (1) year period will be coped with by Sharp, provided that both parties shall discuss and determine on sharing responsibility based on the analysis results thereof subject to the above scope of warranty.

The warranty described herein is only for Sharp product itself which are purchased by or delivered to customer. Damages arising from Sharp product malfunction or failure shall be excepted.

Sharp will not be responsible for the Sharp product due to the malfunction or failures thereof which are caused by:

- (1) storage keep trouble during the inventory in the marketing channel.
- (2) intentional act, negligence or wrong/poor handling.
- (3) equipment which Sharp products are connected to or mounted in.
- (4) disassembling, reforming or changing Sharp products.
- (5) installation problem.
- (6) act of God or other disaster (natural disaster, fire, flood, etc.)
- (7) external factors (abnormal voltage, abnormal electromagnetic wave, fire, etc.)
- (8) special environment (factory, coastal areas, hotspring area, etc.)
- (9) phenomenon which cannot be foreseen based on the practical technologies at the time of shipment,
- (10) the factors not included in the product specification sheet.
- 4. Please contact and consult with a Sharp sales representative for any questions about Sharp product.

### 1. Application

This specification applies to the outline and characteristics of photocoupler Model No. PC817series(Lead-Free Type).

2. Outline Refer to the attached sheet, page 4.

3. Ratings and characteristics Refer to the attached sheet, page 5, 6.

4. Reliability Refer to the attached sheet, page 7.

5. Outgoing inspection Refer to the attached sheet, page 8.

#### 6. Supplement

6.1 Isolation voltage shall be measured in the following method.

(1) Short between anode and cathode on the primary side and between collector and emitter on the secondary side.

(2) The dielectric withstanding tester with zero-cross circuit shall be used.

(3) The wave form of applied voltage shall be a sine wave.(It is recommended that the isolation voltage be measured in insulation oil.)

6.2 Package specifications Refer to the attached sheet, page 9, 10.

6.3 Business dealing name ("O" mark indicates business dealing name of ordered product)

Ordered product	Business dealing name	Rank mark	Ic (mA)
	PC817XNNIP1B	with or without	2.5 to 30.0
	PC817X1NIP1B	A	4.0 to 8.0
	PC817X2NIP1B	В	6.5 to 13.0
	PC817X3NIP1B	С	10.0 to 20.0
	PC817X4NIP1B	D	15.0 to 30.0
	PC817X5NIP1B	A or B	4.0 to 13.0
	PC817X6NIP1B	B or C	6.5 to 20.0
	PC817X7NIP1B	C or D	10.0 to 30.0
	PC817X8NIP1B	A, B or C	4.0 to 20.0
	PC817X9NIP1B	B, C or D	6.5 to 30.0
	PC817X0NIP1B	A, B, C or D	4.0 to 30.0

Test conditions
I <sub>F</sub> =5mA V <sub>CE</sub> =5V
Ta=25°C

6.4 This Model is approved by UL. (Under preparation).

Approved Model No.: PC817

UL file No.: E64380

6.5 This Model is approved by CSA. (Under preparation).

Approved Model No.: PC817

CSA approved mark "

SE.

" shall be indicated on minimum unit package.

6.6 This product is not designed against irradiation.

This product is assembled with electrical input and output.

This product incorporates non-coherent light emitting diode.

# REPERENCE

#### 6.7 ODS materials

This product shall not contain the following materials.

Also, the following materials shall not be used in the production process for this product.

Materials for ODS : CFC<sub>S</sub>, Halon, Carbon tetrachloride, 1.1.1-Trichloroethane (Methyl chloroform)

#### 6.8 Specified brominated flame retardants

Specified brominated flame retardants (PBB and PBDE) are not used in this device at all

### 6.9 Compliance with each regulation

(1) The RoHS directive(2011/65/EU)

This product complies with the RoHS directive(2011/65/EU).

Object substances: mercury, lead, cadmium, hexavalent chromium, polybrominated biphenyls (PBB) and polybrominated diphenyl ethers (PBDE)

(2) Content of six substances specified in Management Methods for Control of Pollution Caused by Electronic Information Products Regulation (Chinese: 电子信息产品污染控制管理力法).

Marking Styles for the Names and Contents of the Hazardous Substances

	Hazardous Substances						
Category	Lead	Mercury	Cadmium	Hexavalent chromium	Polybrominated biphenyls	Polybrominated diphenyl ethers	
	(Pb)	(Hg)	(Cd)	(Cr <sup>6+</sup> )	(PBB)	(PBDE)	
Photocoupler	0	0	0	0	0	0	

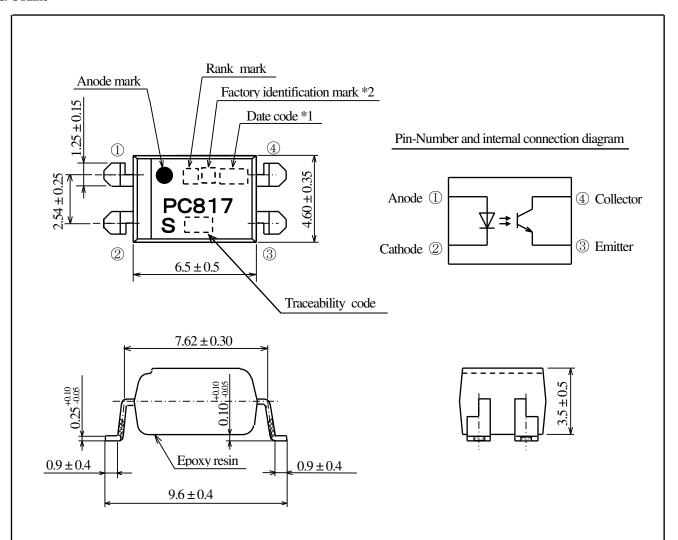
This table is prepared in accordance with the provisions of SJ/T 11364.

#### 7. Notes

Precautions for photocouplers : Attachment-1

 $<sup>\</sup>bigcirc$ : Indicates that said hazardous substance contained in all of the homogeneous materials for this part is below the limit requirement of GB/T 26572

#### 2. Outline



- \*1) Date code: 3 digit indication according to production year and week
- \*2) Factory identification mark apply to the below

K: Kyushu Denshi Co.,Ltd. (Japan products)

A lead tip area and a part of a lead side area ( area) are no-plating.

Pin material : Copper Alloy

Pin finish : SnBi plating (Bi : 1~4%)

Mark : laser marking

Product mass: Approx. 0.22g

UNIT: 1/1 mm

PC817 Outline Dimensions

Name | 1 Co17 Oddine Difficultions

(Business dealing name: PC817X\*NIP1B

## 3. Ratings and characteristics

## 3.1 Absolute maximum ratings

Ta=25°C

	Parameter		Symbol	Rating	Unit
	*1	Forward current	$I_{\mathrm{F}}$	50	mA
Input	*2	Peak forward current	I <sub>FM</sub>	1	A
Input		Reverse voltage	$V_R$	6	V
	*1	Power dissipation	P	70	mW
		Collector-emitter voltage	V <sub>CEO</sub>	80	V
Ontrod		Emitter-collector voltage	V <sub>ECO</sub>	6	V
Output		Collector current	Ic	50	mA
	*1	Collector power dissipation	Pc	150	mW
	*1	Total power dissipation	P <sub>tot</sub>	200	mW
		Operating temperature	Topr	-30 to +100	$^{\circ}\!\mathbb{C}$
		Storage temperature	T <sub>stg</sub>	-55 to +125	$_{\mathbb{C}}$
	*3	Isolation voltage	V <sub>iso(rms)</sub>	5	kV
	*4	Soldering temperature	T <sub>sol</sub>	270	$_{\mathbb{C}}$

## 3.2 Electro-optical characteristics

Ta=25°C

	Parameter	Symbol	Condition	MIN.	TYP.	MAX.	Unit
	Forward voltage		I <sub>F</sub> =20mA	-	1.2	1.4	V
Laguet	Peak forward voltage	V <sub>FM</sub>	I <sub>FM</sub> =0.5A	-	-	3.0	V
Input	Reverse current	$I_R$	V <sub>R</sub> =4V	-	-	10	$\mu$ A
	Terminal capacitance	Ct	V=0, f=1kHz	-	30	250	pF
	Dark current	Park current $I_{CEO}$ $V_{CE}$ =50V, $I_F$ =0		-	-	100	nA
Output	Collector-emitter breakdown voltage	BV <sub>CEO</sub>	I <sub>c</sub> =0.1mA I <sub>F</sub> =0	80	-	-	V
	Emitter-collector breakdown voltage	BV <sub>ECO</sub>	$I_{E}=10 \mu A, I_{F}=0$	6	-	-	V
	Collector current	Ic	I <sub>F</sub> =5mA, V <sub>CE</sub> =5V	2.5	-	30	mA
	Collector-emitter saturation voltage	V <sub>CE(sat)</sub>	$I_F=20mA$ $I_c=1mA$	-	0.1	0.2	V
Twomafan	Isolation resistance	R <sub>ISO</sub>	DC500V 40 to 60%RH	5×10 <sup>10</sup>	$10^{11}$	-	Ω
Transfer charac-	Floating capacitance	$C_{\rm f}$	V=0, f=1MHz	-	0.6	1.0	pF
teristics	Cut-off frequency	$f_c$	V <sub>CE</sub> =5V, I <sub>c</sub> =2mA R <sub>L</sub> =100Ω, -3dB	-	80	-	kHz
	Rise time	tr	V <sub>CE</sub> =2V I <sub>c</sub> =2mA	-	4	18	$\mu$ s
	Fall time	$t_{\rm f}$	$R_L=100\Omega$	-	3	18	$\mu$ s

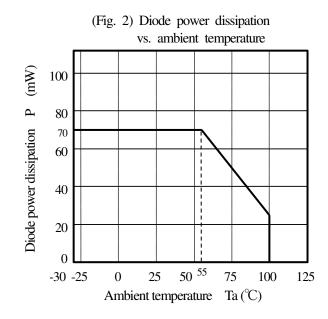
<sup>\*1</sup> The derating factors of absolute maximum ratings due to ambient temperature are shown in Fig. 1to 4.

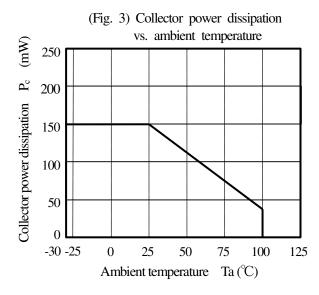
<sup>\*2</sup> Pulse width  $\leq$  100  $\mu$  s, Duty ratio : 0.001 (Refer to Fig. 5)

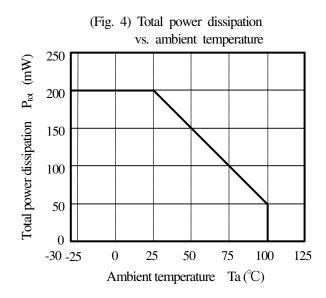
<sup>\*3</sup> AC for 1 min, 40 to 60%RH

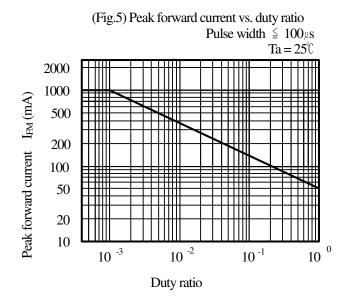
<sup>\*4</sup> For 10s

(Fig. 1) Forward current vs. ambient temperature 50 (mA) 40 Forward current IF 30 20 10 0 50 55 -30 -25 25 75 100 0 125 Ambient temperature Ta ( $^{\circ}$ C)











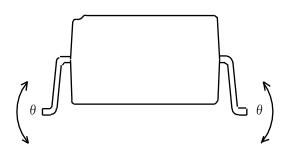
## 4. Reliability

The reliability of products shall satisfy items listed below.

Confidence level: 90% LTPD: 10 or 20

			110 01 20
Test Items	Condition *1	Failure Judgment Criteria	Samples (n) Defective (C)
Solderability	245±3°C, 5s	*2	n=11, C=0
Caldarina haat	(Flow soldering) 270°C, 10 s		- 11 C 0
Soldering heat	(Soldering by hand) 400°C, 3 s		n=11, C=0
Terminal strength (Tension)	Weight: 5N 5 s/each terminal	$V_F$ >U×1.2 $I_R$ >U×2	n=11, C=0
Terminal strength Bending) *3	Weight: 2.5N 2 times/each terminal	I <sub>CEO</sub> >U×2 I <sub>C</sub> <l×0.7< td=""><td>n=11, C=0</td></l×0.7<>	n=11, C=0
Mechanical shock	15km/s², 0.5ms 3 times/±X, ±Y, ±Z direction	V <sub>CE(sat)</sub> >U×1.2	n=11, C=0
Variable frequency vibration	100 to 2000 to 100Hz/4 min 200m/s <sup>2</sup> 4 times/X, Y, Z direction	U: Upper specification limit	n=11, C=0
Temperature cycling	1 cycle -55°C to +125°C (30 min) (30 min) 20 cycles test	L: Lower specification limit	n=22, C=0
High temp. and high Humidity storage	+85°C, 85%RH, 1000h		n=22, C=0
High temp. storage	+125°C, 1000h	]	n=22, C=0
Low temp. storage	-55°C, 1000h	]	n=22, C=0
Operation life	I <sub>F</sub> =50mA, P <sub>tot</sub> =200mW Ta=25°C, 1000h		n=22, C=0

- \*1 Test method, conforms to EIAJ ED 4701.
- \*2 The product whose not-soldered area is more than 5% for all of the dipped area and/or whose pinholes or voids are concentrated on one place shall be judged defect.
- \*3 Terminal bending direction is shown below.



# 5. Outgoing inspection

- 5.1 Inspection items
  - (1) Electrical characteristics  $V_F,\,I_R,\,I_{CEO},\,V_{CE(sat)},\,I_c,\,R_{ISO},\,V_{iso}$
  - (2) Appearance

# 5.2 Sampling method and Inspection level

LTPD sampling inspe	confidence level : $90\%$	
Defect	LTPD (%)	
Major defect	Electrical characteristics(faiure) Marking (Unreadable) Lead form (Deformation)	3
Minor defect	Appearance defect except the above mentioned.	50

### 6.2 Package specifications

- 6.2.1 Taping conditions
- (1) Tape structure and Dimensions (Refer to below in this page.)

The carrier tape has the heat pressed structure of PS material carries tape and PET material cover tape.

(2) Reel structure and Dimensions (Refer to the attached sheet, Page 10)

The taping reel shall be of plastic (PS material)

- (3) Direction of product insertion (Refer to the attached sheet, Page 10)
- (4) The cover tape and carrier tape in one weel shall be joint less.
- (5) To repair failure-taped devices, cutting a bottom of carrier tape or a cover tape with a cutter.

After replacing the cut portion shall be sealed with adhesive tape.

6.2.2 Adhesiveness of cover tape

The exfoliation force between carrier tape and cover tape shall be 0.2N to 0.7N

6.2.3 Rolling method and quantity

Wind the tape back on the reel so that the cover tape will be outside the tape.

Attach more than 18cm of blank tape to the trailer and the leader of the tape

And fix the leader with adhesive tape. One reel basically contain 2000pcs

- 6.2.4 Outer packing appearance (Refer to the attached sheet, Page 10)
- 6.2.5 The label with following information shall be pasted at appointed place of the outer packing case.

\*Model No. \*(Business dealing name) \*Lot No. \*Quantity

\*Country of origin \*Company name \*Inspection date specified

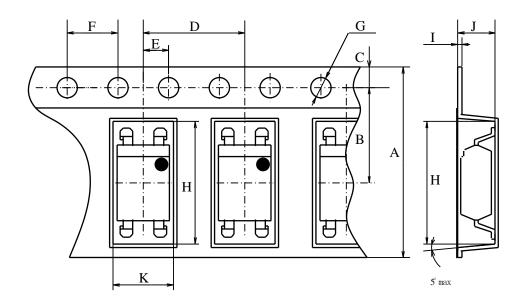
6.2.6 Storage condition

Taped products shall be stored at the temperature 5 to  $30^{\circ}$ C and the humidity 70%RH or less away from direct sunlight.

6.2.7 Safety protection during shipping

There shall be no deformation of component or degradation of electrical characteristics due to shipping.

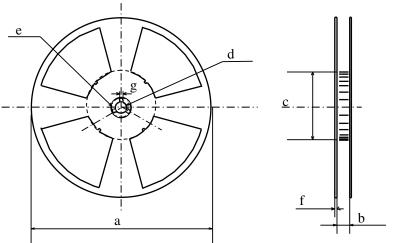
#### Carrier tape structure and Dimensions



Dimensions list (Unit:mm)

A	В	C	D	Е	F	G	Н	I	J	K
16.0±0.3	7.5±0.1	1.75±0.1	8.0±0.1	2.0±0.1	4.0±0.1	φ 1.5 <sup>+0.1</sup> <sub>-0</sub>	10.3±0.1	0.40±0.05	4.0±0.1	5.3±0.1

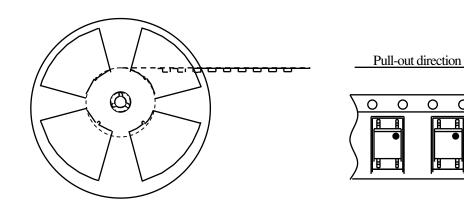
### Reel structure and Dimensions



## Dimensions list (Unit:mm)

a	b	c	d
(330)	$17.5 \pm 1.5$	$\phi 100.0 \pm 1.0$	$\phi$ 13.0 $\pm$ 0.5
e	f	g	
$\phi 21.0 \pm 1.0$	$2.0\pm0.5$	$2.0\pm0.5$	

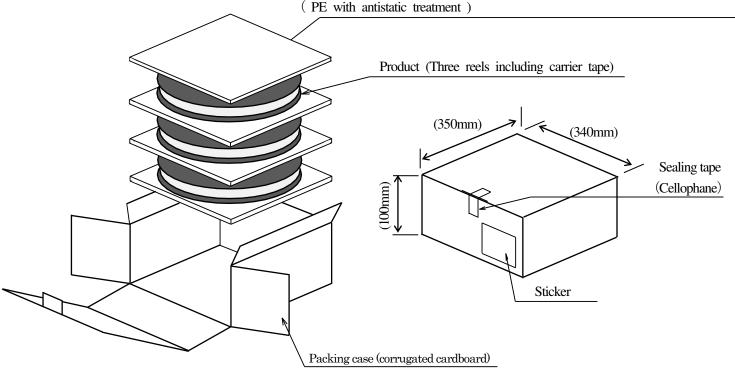
## Direction of product insertion



## Outer packing appearance

# Cushioning pad

Total 4 sheets :Each 1 sheet in top side, bottom side ,and between each reels. ( PE with antistatic treatment )



Regular packing mass: Approx. 2.6kg

): Reference dimensions



#### Precautions for Photocouplers

#### 1 Cleaning

(1) Solvent cleaning: Solvent temperature 45°C or less

Immersion for 3 min or less

(2) Ultrasonic cleaning: The effect to device by ultrasonic cleaning differs by cleaning bath size, ultrasonic power output,

cleaning time, PCB size or device mounting condition etc. Please test it in actual using condition

and confirm that any defect doesn't occur before starting the ultrasonic cleaning.

(3) Applicable solvent: Ethyl alcohol, Methyl alcohol, Isopropyl alcohol

When the other solvent is used, there are cases that the packaging resin is eroded.

Please use the other solvent after thorough confirmation is performed in actual using condition.

#### 2. Circuit design

(1) The LED used in the Photocoupler generally decreases the light emission power by operation. In case of long operation time, please design the circuit in consideration of the degradation

of the light emission power of the LED. (50%/5years)

(2) There are cases that the deviation of the CTR and the degradation of the relative light emission power of the LED increase when the setting value of I<sub>F</sub> is less than 1.0mA. Please design the circuit in consideration of this point.

#### 3. Precautions for Soldering

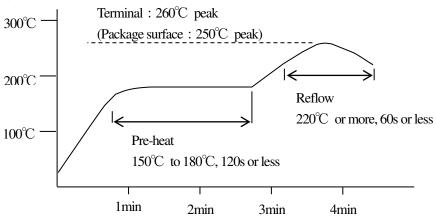
(1) In the case of flow soldering (Whole device dipping.)

It is recommended that flow soldering should be at 270°C or less for 10 s or less

(Pre-heating:  $100 \text{ to } 150^{\circ}\text{C}$ , 30 to 80s). (2 times or less)

(2) If solder reflow:

It is recommended to be done at the temperature and the time within the temperature profile as shown in the figure below. (2 times or less)



(3) In the case of hand soldering

What is done on the following condition is recommended. (2 times or less)

Soldering iron temperature: 400°C or less

Time: 3s or less

(4) The form of a lead tip part

There is production tolerance as shown in the following figure



(5) Other precautions

Depending on equipment and soldering conditions (temperature, Using solder etc.),

the effect to the device and the PCB is different.

Please confirm that there is no problem on the actual use conditions in advance.